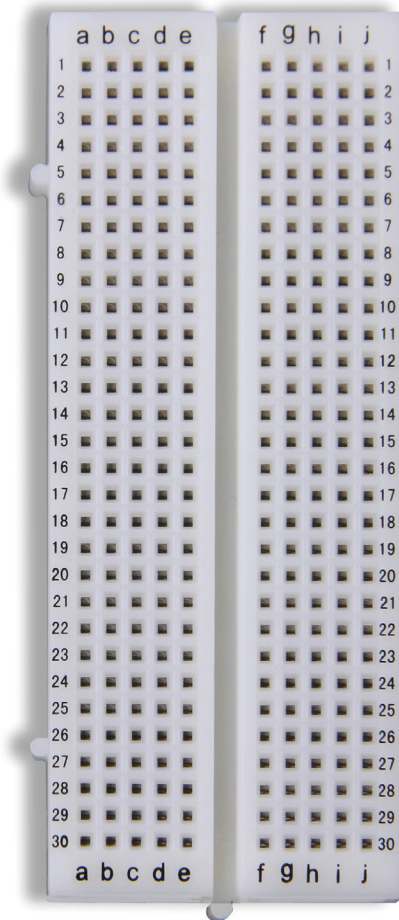# GS-300

300 Tie-Point, Solderless Breadboard

Applications

The GS-300 is a modular type solderless breadboard that connects with the GS-050 bus strip to make a 400 tie point breadboard (GS-400). Expandable in two dimensions, it is a great way to prototype low frequency or DC powered circuits. They are ideal for:

- Educational labs
- Hobbyists

Features

- 300 Tie-points
- ABS plastic body
- Square hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 3 total 16-pin ICs
- Measures 3.7 x 8.6 x 1.0 cm
- Weighs 22 g
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

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22820 Savi Ranch Parkway
Yorba Linda, CA 92887
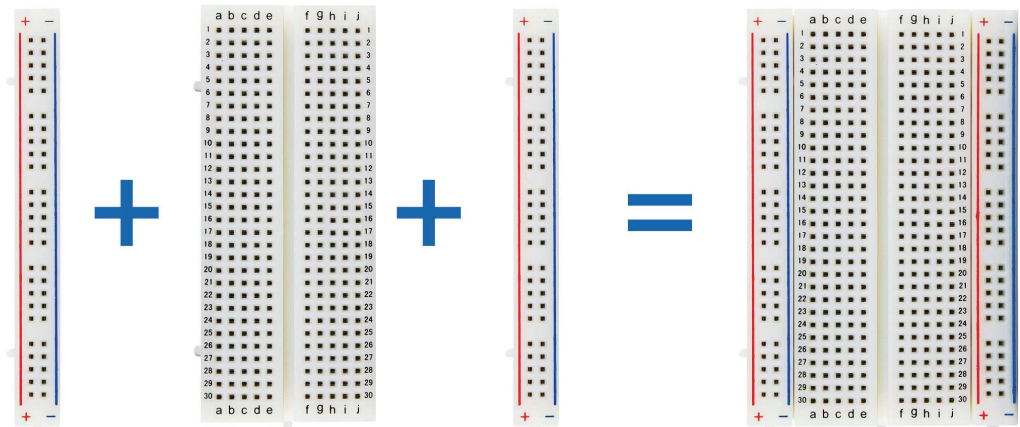*800-572-1028*
globalspecialties.com

GS-300

300 Tie-Point, Solderless Breadboard

Applications

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GS-400 Components

GS-050* + GS-300 + GS-050* = GS-400

*The GS-050 is sold as a pack of two

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